



ALPHA & OMEGA
SEMICONDUCTOR

AO4262E

60V N-Channel AlphaSGT™

General Description

- Trench Power AlphaSGT™ technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- ESD protected

Applications

- High efficiency power supply
- Secondary synchronous rectifier

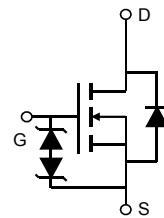
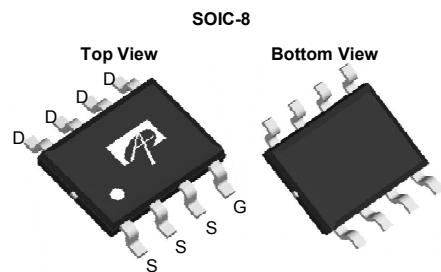
Product Summary

V_{DS}	60V
I_D (at $V_{GS}=10V$)	16.5A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 6.5mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 8.5mΩ

Typical ESD protection

HBM Class 2

100% UIS Tested
100% R_g Tested



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AO4262E	SO-8	Tape & Reel	3000

Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	16.5	A
$T_A=70^\circ C$		13.0	
Pulsed Drain Current ^C	I_{DM}	65	
Avalanche Current ^C	I_{AS}	23	A
Avalanche energy $L=0.3mH$ ^C	E_{AS}	79	mJ
V_{DS} Spike ^G	V_{SPIKE}	72	V
$T_A=25^\circ C$		3.1	W
Power Dissipation ^B	P_D	2.0	
$T_A=70^\circ C$		-55 to 150	°C
Junction and Storage Temperature Range	T_J, T_{STG}		

Thermal Characteristics

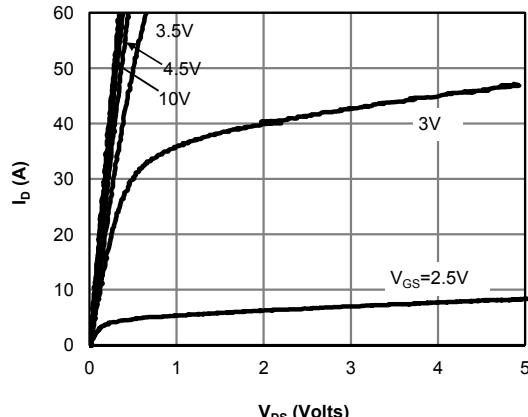
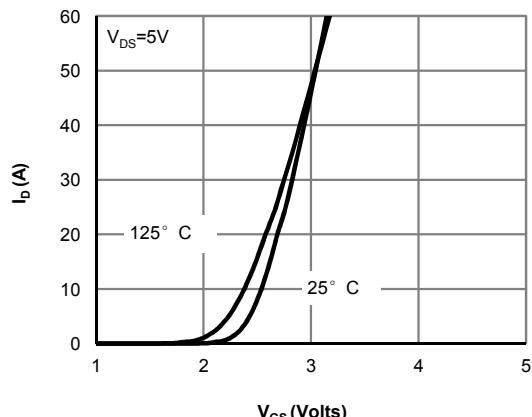
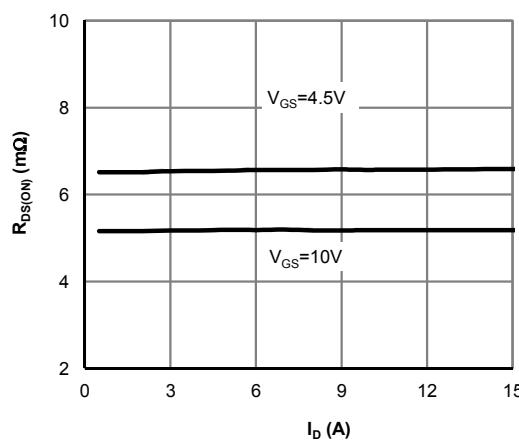
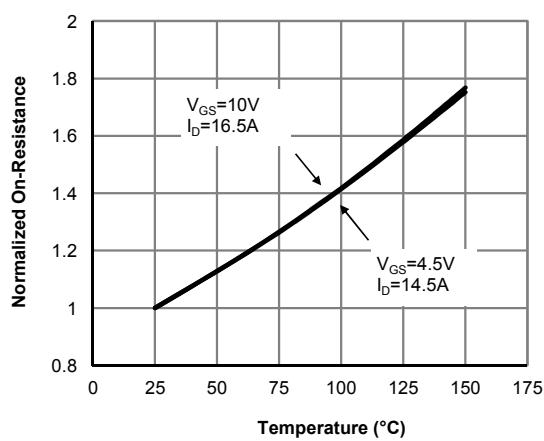
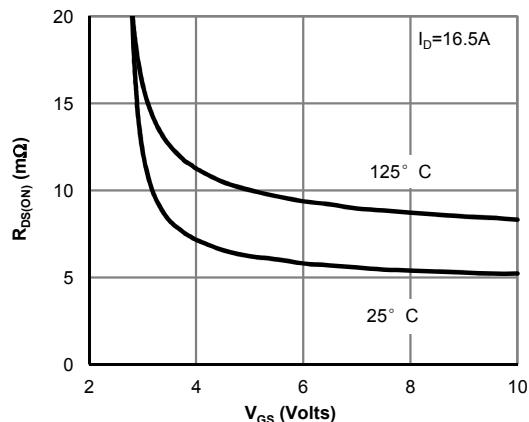
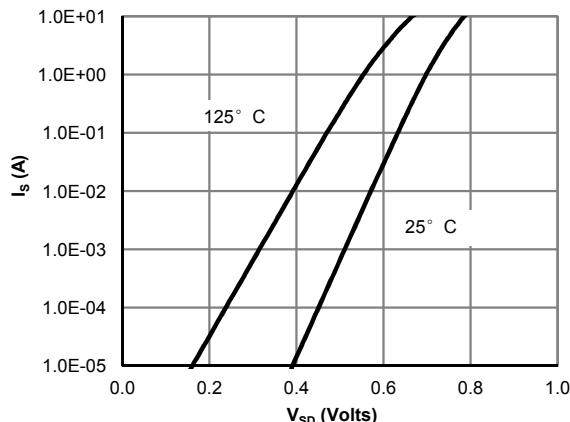
Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A $t \leq 10s$	$R_{\theta JA}$	31	40	°C/W
Maximum Junction-to-Ambient ^{A,D} Steady-State		59	75	°C/W
Maximum Junction-to-Lead	$R_{\theta JL}$	16	24	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	60			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=60\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$		1	5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$			±10	μA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.2	1.65	2.2	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=16.5\text{A}$ $T_J=125^\circ\text{C}$		5.2	6.5	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=14.5\text{A}$		8.3	10.5	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=16.5\text{A}$		6.6	8.5	$\text{m}\Omega$
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$	0.7	1	1	V
I_S	Maximum Body-Diode Continuous Current				4	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$		1652		pF
C_{oss}	Output Capacitance			520		pF
C_{rss}	Reverse Transfer Capacitance			52		pF
R_g	Gate resistance	$f=1\text{MHz}$	0.6	1.3	2.0	Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=30\text{V}, I_D=16.5\text{A}$		30	45	nC
$Q_g(4.5\text{V})$	Total Gate Charge			15	25	nC
Q_{gs}	Gate Source Charge			3.5		nC
Q_{gd}	Gate Drain Charge			6.5		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=30\text{V}, R_L=1.8\Omega, R_{\text{GEN}}=3\Omega$		6		ns
t_r	Turn-On Rise Time			5		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			29		ns
t_f	Turn-Off Fall Time			7		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=16.5\text{A}, di/dt=500\text{A}/\mu\text{s}$		19		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=16.5\text{A}, di/dt=500\text{A}/\mu\text{s}$		60		nC

- A. The value of R_{JJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any given application depends on the user's specific board design.
- B. The power dissipation P_D is based on $T_{J(\text{MAX})}=150^\circ\text{C}$, using $\leq 10\text{s}$ junction-to-ambient thermal resistance.
- C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.
- D. The R_{JJA} is the sum of the thermal impedance from junction to lead R_{JLL} and lead to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(\text{MAX})}=150^\circ\text{C}$. The SOA curve provides a single pulse rating.
- G. The spike duty cycle 5% max, limited by junction temperature $T_J(\text{MAX})=125^\circ\text{C}$.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

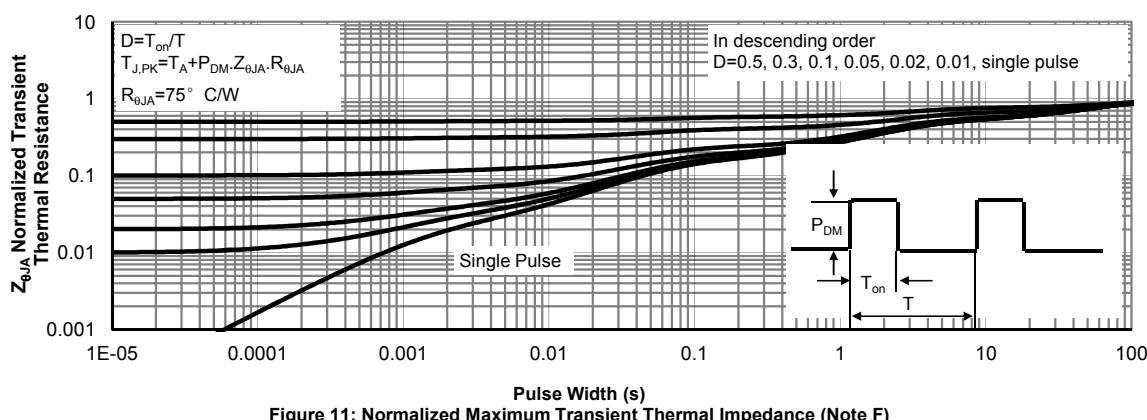
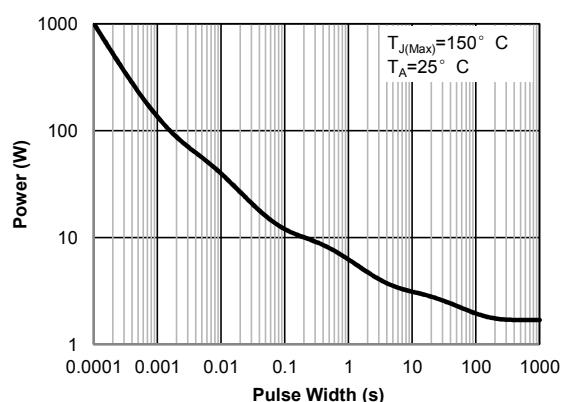
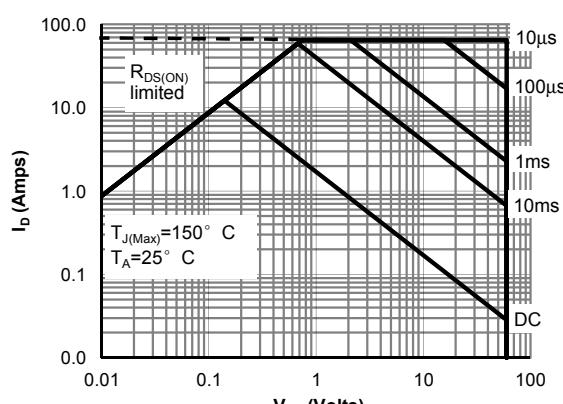
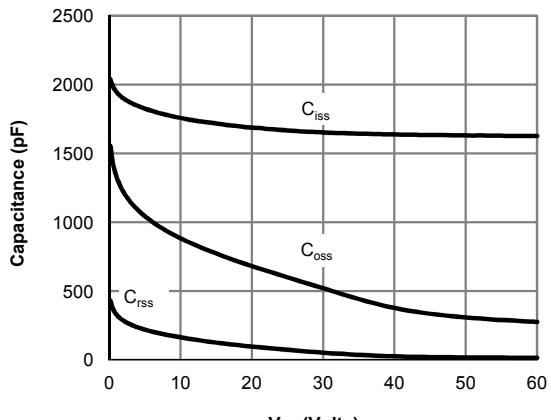
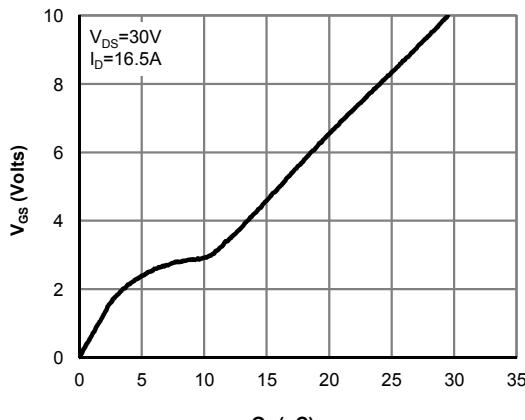
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure A: Gate Charge Test Circuit & Waveforms

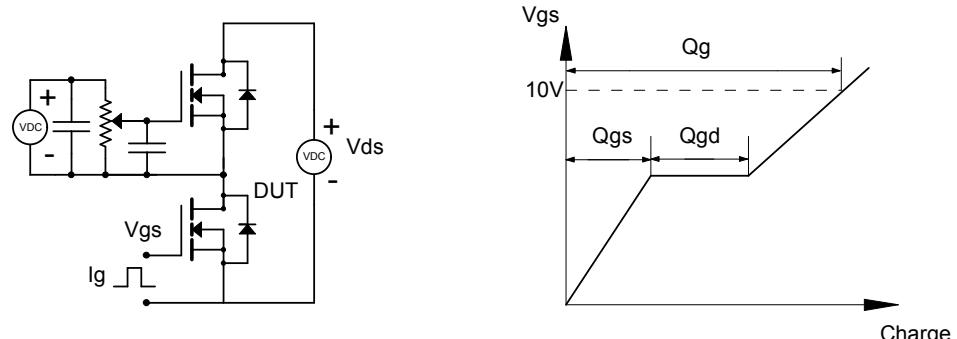


Figure B: Resistive Switching Test Circuit & Waveforms

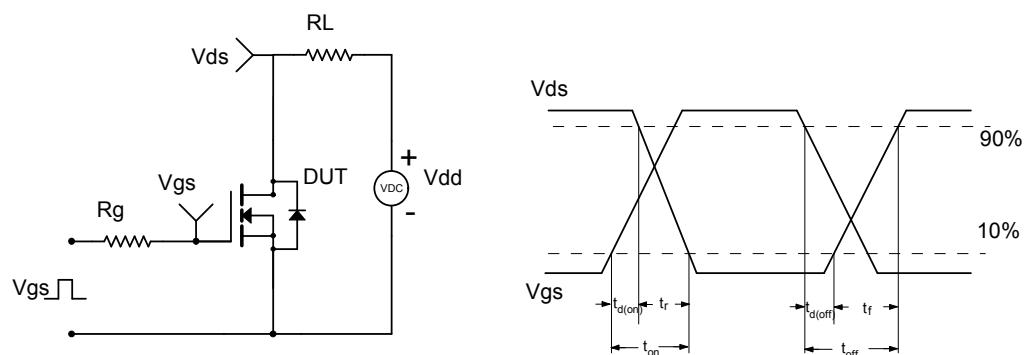


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

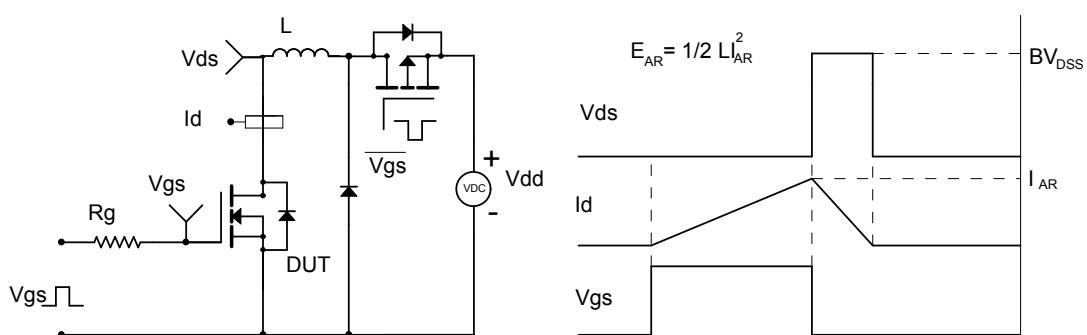
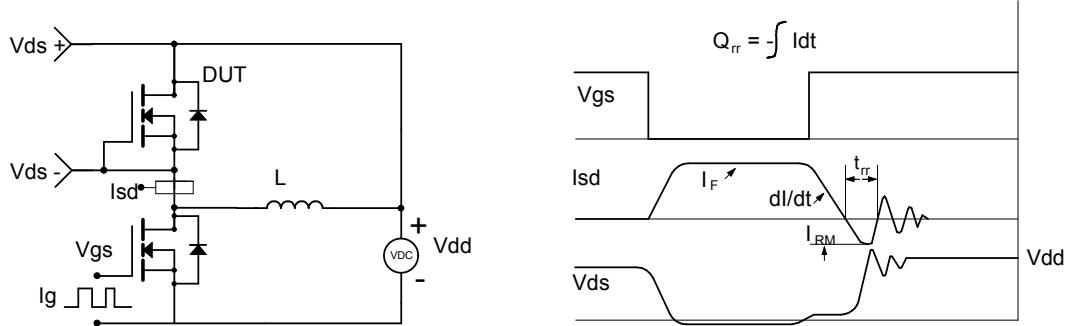


Figure D: Diode Recovery Test Circuit & Waveforms



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